APPLICA	BLE STANI	DARD									
OPERATING			55 ° 0 TO 05 °			RAGE			10.00 TO 00.00	(0)	
	TEMPERATURE RANGE VOLTAGE		-55 °C TO 85 °	,C (i)		PERATURE RANGE ERATING HUMIDITY			-10 °C TO 60 °C		
RATING			100 V AC		RAN	GE			40 % TO 80 %)	
	CURRENT		0.5 A		STORAGE H		IMIDITY	40 % TO 70 %			
	CORRENT			·IEIC A	FICATIONS						
17		ı			HON	<u>ა</u>		-0111	DEMENTO	I O T	
	EM		TEST METHOD				R	=QUI	REMENTS	ĮQΙ	АТ
CONSTRU		MOUALL	V AND DV MEACHDING INC	STOLIMEN	JT	ACCOR	DINC T	-O DD	AWING.	Τ.,	Τ.,
MARKING		VISUALLY AND BY MEASURING INSTRUMENT. CONFIRMED VISUALLY.				ACCOR	DING	O DR	AVVING.	×	×
ELECTRIC CHARACT											1 ^
CONTACT RESISTANCE		20 mV MAX, 1 mA(DC OR 1000Hz)				60 mΩ MAX. ⁽³⁾				×	
INSULATION RESISTANCE		100 V DC.				500 MΩ MIN.				×	
VOLTAGE PROOF		300 V AC FOR 1 min.				NO FLASHOVER OR BREAKDOWN.				×	
MECHANI	CAL CHAR	ACTERI	STICS								
INSERTION AND WITHDRAWAL FORCES		MEASURED BY APPLICABLE CONNECTOR.				INSERTION FORCE: 24.6 N MAX. WITHDRAWAL FORCE: 2.05 N MIN.				×	
MECHANICAL		50 TIMES INSERTIONS AND EXTRACTIONS.			S.	① CONTACT RESISTANCE: 80 mΩ MAX. (3)				×	
OPERATION						② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.					
VIBRATION		FREQUENCY 10 TO 55 Hz,				 NO ELECTRICAL DISCONTINUITY OF 1 μs. NO DAMAGE, CRACK AND LOOSENESS OF PARTS. 				×	
		SINGL AMPLITUDE : 0.75 mm,									
		FOR 2 h IN 3 DIRECTIONS. 490 m/s ² , DURATION OF PULSE 11 ms								×	
		FOR 3 TIMES IN 3 DIRECTIONS.								^	
ENVIRON	MENTAL C	HARAC	TERISTICS								
DAMP HEAT		EXPOSE	OAT 40±2°C, 90 ~ 95	5 %, 96	h.	① CON	ITACT I	RESIS	STANCE: 80 mΩ MAX. ⁽³⁾	×	
(STEADY STATE)						_			SISTANCE: 500 M Ω MIN.		
DRY HEAT		EXPOSED AT 85±2 °C, 96 h							RACK AND LOOSENESS		
RAPID CHANGE OF		TEMPERATURE -55→+5~+35→+85→+5~+35°C				OF F	PARTS.			×	
TEMPERATURE		TIME $30 \rightarrow 5 \text{ MAX} \rightarrow 30 \rightarrow 5 \text{ MAX min.}$									
		UNDER 5 CYCLES. EXPOSED IN 5 % SALT WATER SPRAY FOR				1 CONTACT RESISTANCE: 80 m Ω MAX. (3)				×	
CONTRODICT CALL MICT		48 h.				② NO HEAVY CORROSION.				^	
SULFUR DIOXIDE RESISTANCE TO SOLDERING HEAT		EXPOSED IN 25 PPM FOR 96 h.								×	
		(TEST STANDARD: JIS C 60068) 1)REFLOW SOLDERING:				NO DEFORMATION OF CASE OF EXCESSIVE					
		REFLOW 2 TIMES UNDER THE TEMPERATURE PROFILE SHOWN BELOW. 50s(MAX) 230°C 220°C 180°C 150°C 60~120s 60s(MAX) 2) SOLDERING IRONS: 360°C MAX. FOR 5 sec.				LOOSENESS OF THE TERMINAL.				×	
										×	
SOLDERABILITY		SOLDERED AT SOLDER TEMPERATURE 240±3°C FOR IMMERSION DURATION, 3 sec.			A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95 % OF THE				×		
COUNT		ECODIDATION OF BELLIOUS			SURFACE BEING IMMERSED.				<u> </u>	<u> </u>	
COUN	ı DI	SCRIPTIO	SCRIPTION OF REVISIONS DESI		DESIG	INED			CHECKED	DA	TE
						1400001/55					
			RISE CAUSED BY CURRENT-CARRYING. IG-TERM STORAGE STATE			APPROV			HS. OKAWA		5. 07
	FOR THE UNU	SED PRODUCT BEFORE ASSEMBLY TO PCB.				CHECKED			HT. YAMAGUCHI	08. 05. 07 08. 05. 07	
(UCTOR RESISTANCE OF CABLE IN CASE THE MATED CABLE TYPE.(L=12mm)				DESIGNED		KN. SHIBUYA		
Unless oth			r to JIS-C-5402.			DRAWN		٧N	AH. EDASHIGE	I. EDASHIGE 08. 05.	
						RAWING NO. ELC4-156992-				-00	
RS	SI	PECIFICATION SHEET PA			PART	NO. FX15SC-41S-0. 5SV					
HIROSE ELECTRIC CO., LTD. CODE					ENO. CL575-2205-8-00 🛆 1/1					1/1	
FORM HD0011-	·7-1										